

2016L Series

Surface Mount



Description

The 2016L Series PTC provides surface mount overcurrent protection for low voltage ($\leq 60V$) applications where resettable protection is desired.

Features

- RoHS compliant, lead-free and halogen-free
- Fast response to fault currents
- High voltage
- Low-profile

Applications

- IEEE 1394 port protection
- Powered ethernet port protection (IEEE 802.3 af)
- Automotive electronic control module protection
- Low voltage telecom equipment protection

Additional Information



Resources



Accessories



Samples

Agency Approvals

Agency	Agency File Number
c UL US	E183209
A	R50119118

Electrical Characteristics

Part Number	Marking	I_{hold} (A)	I_{trip} (A)	V_{max} (Vdc)	I_{max} (A)	P_d typ. (W)	Maximum Time To Trip		Resistance		Agency Approvals	
							Current (A)	Time (Sec.)	R_{min} (Ω)	R_{1max} (Ω)	c UL US	A
2016L030	LF030	0.30	0.60	60	20	1.40	1.5	3.0	0.500	2.300	X	X
2016L050	LF050	0.55	1.10	60	20	1.40	2.5	5.0	0.200	1.000	X	X
2016L075/60	LF075	0.75	1.50	60	20	1.40	8.0	0.5	0.130	0.900	X	X
2016L100	LF100	1.10	2.20	15	40	1.40	8.0	0.5	0.100	0.400	X	X
2016L100/33	LF100-33	1.10	2.20	33	40	1.40	8.0	0.5	0.100	0.400	X	X
2016L150	LF150	1.50	3.00	15	40	1.40	8.0	1.0	0.070	0.180	X	X
2016L150/33	LF150-33	1.50	3.00	33	40	2.0	8.00	1.00	0.070	0.180	X	X
2016L200	LF200	2.00	4.20	6	40	1.40	8.0	3.0	0.048	0.100	X	X
2016L260/24	LF260-24	2.60	5.00	24	40	1.6	8.00	5.00	0.025	0.075	X	X
2016L300/16	LF300	3.00	5.00	16	40	1.6	8.00	10.00	0.015	0.048	X	X
2016L500	LF500	5.00	10.00	6	100	2.0	25.00	2.00	0.005	0.025	X	X

I_{hold} = Hold current: maximum current device will pass without tripping in 20°C still air.

I_{trip} = Trip current: minimum current at which the device will trip in 20°C still air.

V_{max} = Maximum voltage device can withstand without damage at rated current (I_{max})

I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max})

P_d = Power dissipated from device when in the tripped state at 20°C still air.

R_{min} = Minimum resistance of device in initial (un-soldered) state.

R_{typ} = Typical resistance of device in initial (un-soldered) state.

R_{1max} = Maximum resistance of device at 20°C measured one hour after tripping or reflow soldering of 260°C for 20 sec.

Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

* Agency Approval is Pending

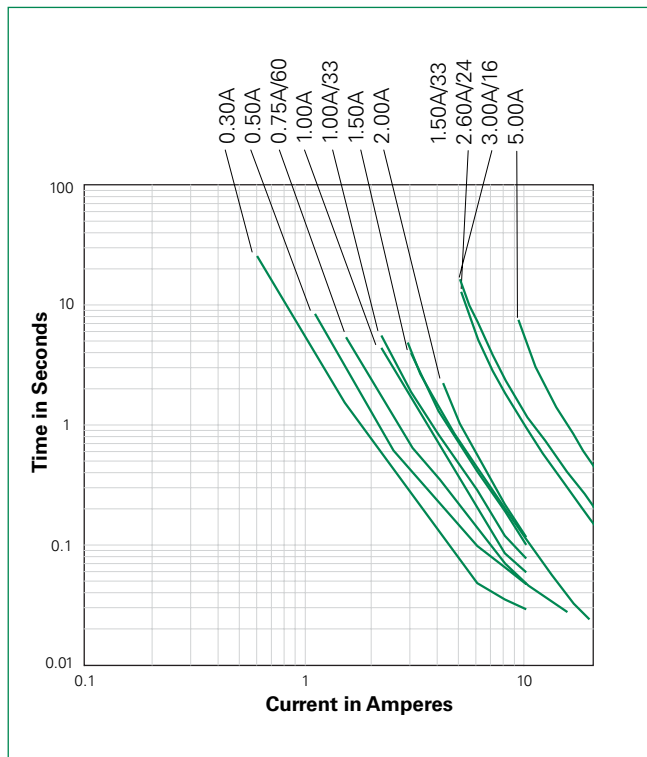
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Temperature Derating

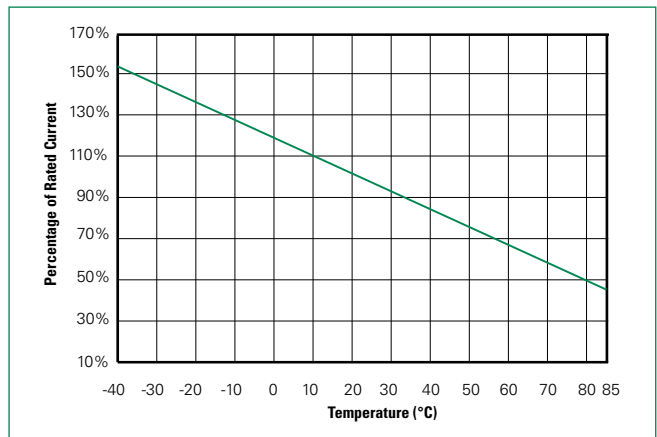
Part Number	Ambient Operation Temperature								
	-40°C	-20°C	0°C	20°C	40°C	50°C	60°C	70°C	85°C
	Hold Current (A)								
2016L030	0.45	0.40	0.35	0.30	0.25	0.23	0.20	0.18	0.14
2016L050	0.93	0.95	0.65	0.55	0.42	0.38	0.33	0.30	0.23
2016L075/60	1.05	1.06	0.85	0.75	0.60	0.55	0.45	0.40	0.30
2016L100	1.66	1.47	1.29	1.10	0.91	0.83	0.73	0.64	0.50
2016L100/33	1.66	1.47	1.29	1.10	0.91	0.83	0.73	0.64	0.50
2016L150	2.26	2.00	1.76	1.50	1.24	1.13	1.00	0.87	0.68
2016L150/33	2.26	2.00	1.76	1.50	1.24	1.13	1.00	0.87	0.68
2016L200	2.80	2.50	2.19	2.00	1.84	1.74	1.50	1.34	1.14
2016L260/24	3.82	3.46	3.06	2.60	2.24	2.03	1.82	1.60	1.26
2016L300/16	4.40	3.96	3.52	3.00	2.65	2.43	2.20	1.96	1.59
2016L500	7.29	6.57	5.86	5.00	4.38	4.02	3.66	3.26	2.66

Average Time Current Curves



The average time current curves and Temperature Derating curve performance is affected by a number of variables, and these curves provided as guidance only. Customer must verify the performance in their application.

Temperature Derating Curve



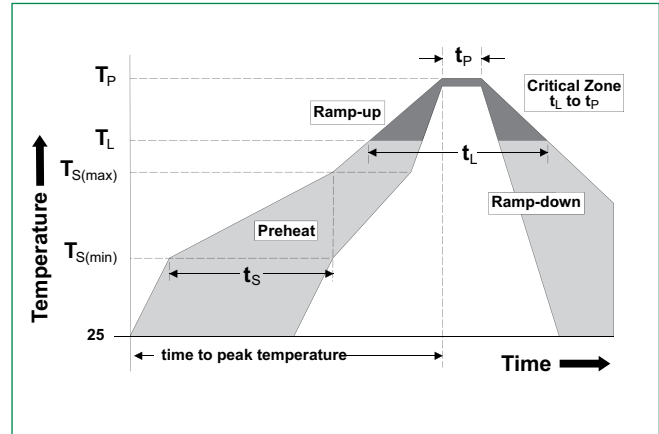
Note: Typical Temperature derating curve, refer to table for derating data

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Soldering Parameters

Profile Feature		Pb-Free Assembly
Average Ramp-Up Rate ($T_{S(max)}$ to T_p)		3°C/second max
Pre Heat:	Temperature Min ($T_{S(min)}$)	150°C
	Temperature Max ($T_{S(max)}$)	200°C
	Time (Min to Max) (t_s)	60 – 180 secs
Time Maintained Above:	Temperature (T_L)	217°C
	Temperature (T_L)	60 – 150 seconds
Peak / Classification Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.



Physical Specifications

Terminal Material	Solder-Plated Copper (Solder Material: Matte Tin(Sn))
Lead Solderability	Meets EIA Specification RS186-9E, ANSI/J-STD-002 Category 3.

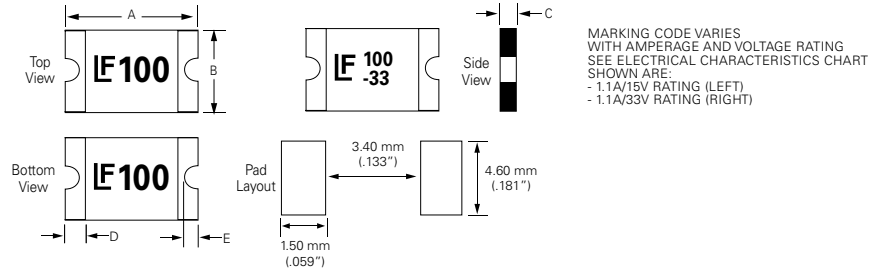
Environmental Specifications

Operating Temperature	-40°C to +85°C
Maximum Device Surface Temperature in Tripped State	125°C
Passive Aging	+85°C, 1000 hours -/+5% typical resistance change
Humidity Aging	+85°C, 85%, R.H., 1000 hours -/+5% typical resistance change
Thermal Shock	MIL-STD-202, Method 107 +85°C/-40°C 20 times -30% typical resistance change
Solvent Resistance	MIL-STD-202, Method 215 No change
Vibration	MIL-STD-883, Method 2007, Condition A No change
Moisture Sensitivity Level	Level 1, J-STD-020

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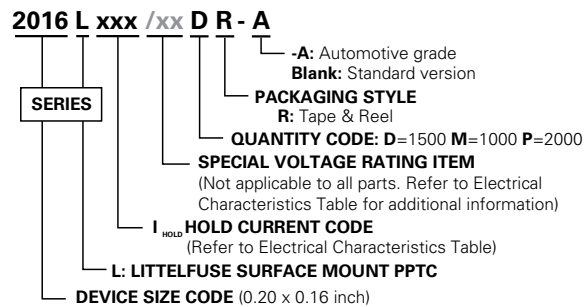
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Dimensions (mm)



Part Number	A				B				C				D				E			
	Inches		mm		Inches		mm		Inches		mm		Inches		mm		Inches		mm	
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
2016L030									0.03	0.05	0.75	1.25								
2016L050									0.05	0.08	1.20	2.00								
2016L075/60								4.43	0.05	0.08	1.20	2.00								
2016L100									0.02	0.03	0.50	0.75								
2016L100/33									0.03	0.05	0.75	1.25								
2016L150	0.19	0.21	4.72	5.44	0.15	0.17	3.7		0.03	0.06	0.75	1.55	0.01	0.06	0.3	1.5	0.01	0.03	0.25	0.65
2016L150/33								4.43	0.03	0.06	0.80	1.60								
2016L200								4.43	0.02	0.03	0.50	0.75								
2016L260/24																				
2016L300/16								4.43	0.03	0.06	0.80	1.60								
2016L500																				

Part Ordering Number System



Packaging

Part Number	Ordering Number	Halogen Free	I _{hold} (A)	I _{hold} Code	Voltage Option	Packaging Option	Quantity	Quantity & Packaging Codes
2016L030	2016L030DR	Yes	0.30	030		Tape and Reel	1500	DR
2016L050	2016L050MR	Yes	0.55	050		Tape and Reel	1000	MR
2016L075/60	2016L075/60MR	Yes	0.75	075	/60	Tape and Reel	1000	MR
2016L100	2016L100PR	Yes	1.10	110		Tape and Reel	2000	PR
2016L100/33	2016L100/33DR	Yes	1.10	110	/33	Tape and Reel	1500	DR
2016L150	2016L150DR	Yes	1.50	150		Tape and Reel	1500	DR
2016L150/33	2016L150/33DR	Yes	1.50	150	/33	Tape and Reel	1,500	DR
2016L200	2016L200PR	Yes	2.00	200		Tape and Reel	2000	PR
2016L260/24	2016L260/24MR	Yes	2.60	260	/24	Tape and Reel	1,000	MR
2016L300/16	2016L300/16MR	Yes	3.00	300	/16	Tape and Reel	1,000	MR
2016L500	2016L500DR	Yes	5.00	500	/6	Tape and Reel	1,500	DR

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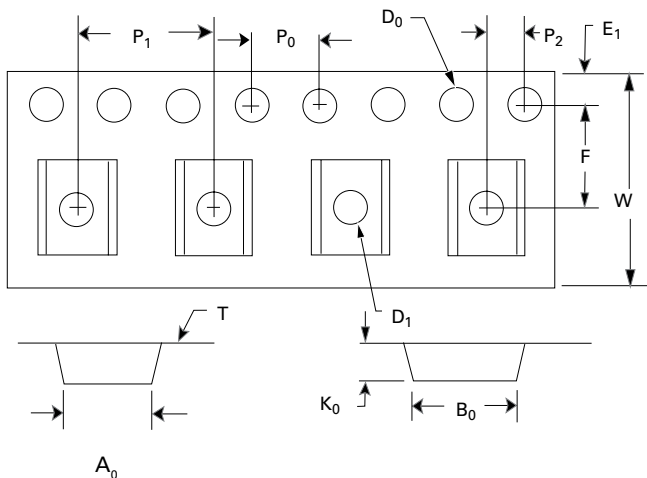
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Tape and Reel Specifications

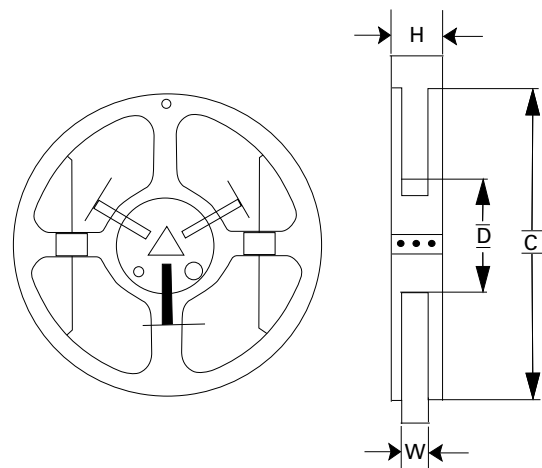
TAPE SPECIFICATIONS: EIA-481-1 (mm)				REEL DIMENSIONS: EIA-481-1 (mm)	
	2016L100 2016L200	2016L030 2016L100/33 2016L150 2016L150/33 2016L500	2016L050 2016L075/60 2016L260/24 2016L300/16		
W	12.0+/-0.30	12.0+/-0.30	12.0+/-0.30	C	Ø178.0+/-1.0
F	5.50+/-0.05	5.50+/-0.05	5.50+/-0.05	D	Ø60.2+/-0.5
E ₁	1.75+/-0.10	1.75+/-0.10	1.75+/-0.10	H	16.0+/-0.5
D ₀	1.55+/-0.05	1.55+/-0.05	1.55+/-0.05	W	13.2+/-1.5
D ₁	1.50 (MIN)	1.50+/-0.10	1.50+/-0.10		
P ₀	4.0+/-0.10	4.0+/-0.10	4.0+/-0.10		
P ₁	8.0+/-0.10	8.0+/-0.10	8.0+/-0.10		
P ₂	2.0+/-0.05	2.0+/-0.05	2.0+/-0.05		
A ₀	4.40+/-0.10	4.48+/-0.10	4.45+/-0.10		
B ₀	5.50+/-0.10	5.40+/-0.10	5.48+/-0.10		
T	0.25+/-0.10	0.25+/-0.10	0.25+/-0.10		
K ₀	0.75+/-0.10	1.36+/-0.10	1.86+/-0.10		
Leader Min.	390	390	390		
Trailer Min.	160	160	160		

Tape and Reel Diagram

Tape Specifications



Reel Specifications



Warning

- Users should independently evaluate the suitability of and test each product selected for their own application.
- Operation beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- These devices are intended for protection against damage caused by occasional overcurrent or overtemperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Contamination of the PPTC material with certain silicone-based oils or some aggressive solvents can adversely impact the performance of the devices.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- PPTC devices are not recommended for installation in applications where the device is constrained such that its PTC properties are inhibited, for example in rigid potting materials or in rigid housings, which lack adequate clearance to accommodate device expansion.
- Operation in circuits with a large inductance can generate a circuit voltage ($L di/dt$) above the rated voltage of the device.

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